Specification of Thermoelectric Module

TEFC1-02511L1-ALN

Description

The 25 couples, 8.6 mm × 4.5 mm/5.1 mm size module which is made of selected high performance ingot to achieve superior cooling performance and greater delta T up to 74 °C, designed for superior cooling and heating applications. If higher operation or processing temperature is required, please specify, we can design and manufacture the custom made module according to your special requirements.

Features

- No moving parts, no noise, and solid-state
- Compact structure, small in size, light in weight
- Environmental friendly
- RoHS compliant
- Precise temperature control
- Exceptionally reliable in quality, high performance

Application

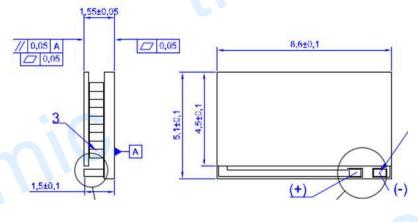
- Food and beverage service refrigerator
- Portable cooler box for cars
- Liquid cooling
- Temperature stabilizer
- CPU cooler and scientific instrument
- Photonic and medical systems

Performance Specification Sheet

Th (°C)	27	50	Hot side temperature at environment: dry air, N ₂	
DT _{max} (°C)	74	83	Temperature Difference between cold and hot side of the	
			module when cooling capacity is zero at cold side	
U _{max} (Voltage)	3.2	3.5	Voltage applied to the module at DT _{max}	
I _{max} (amps)	1.1	1.1	DC current through the modules at DT _{max}	
Q _{Cmax} (Watts)	2.39	2.50	Cooling capacity at cold side of the module under DT=0 °C	
AC resistance (ohms)	2.4	2.6	The module resistance is tested under AC	
Tolerance (%)	10%		For thermal and electricity parameters	

Geometric Characteristics Dimensions in millimeters

Manufacturing Options



A. Solder: B. Sealant:

1. T100: BiSn (Tmelt=138°C)

1. NS: No sealing (Standard)

2. T200: CuAgSn (Tmelt = 217° C)

2. SS: Silicone sealant

3. T240: SbSn (Tmelt = 240° C)

3. EPS: Epoxy sealant

C. Ceramics:

1. Alumina (Al₂O₃, white 96%)

D. Ceramics Surface Options:1. Blank ceramics (not metalized)

2. Aluminum Nitride (AlN)

2. Metalized

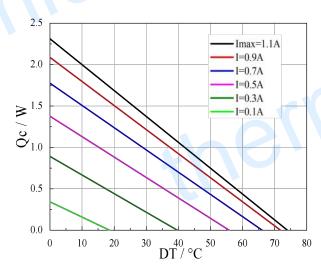
Thickness Flatness/ Parallelism

Suffix	Thickness (mm)	Flatness/ Parallelism (mm)	Lead wire length(mm) Standard/Optional length
TF	0:1.55±0.1	0:0.03/0.03	Copper Posts/Specify

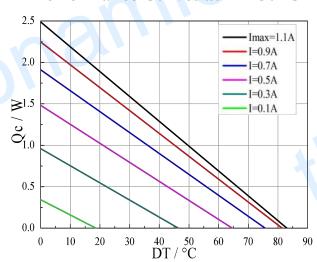
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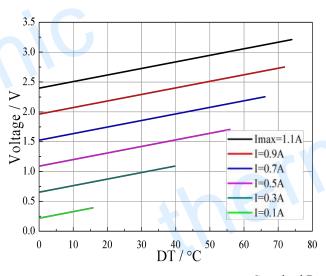
Performance Curves at Th=27 °C

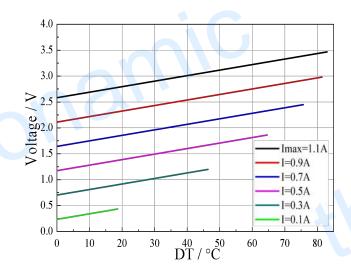


Performance Curves at Th=50 °C

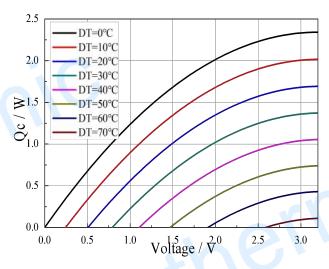


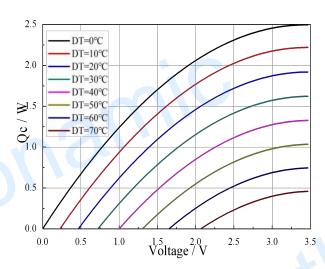
Standard Performance Graph Qc= f(DT)





Standard Performance Graph $V=f(\Delta T)$





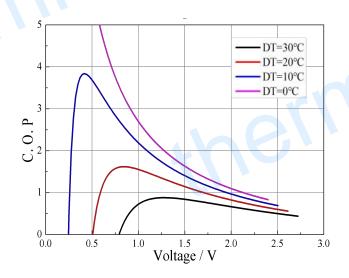
Standard Performance Graph Qc = f(V)

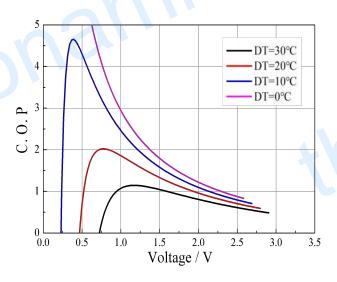
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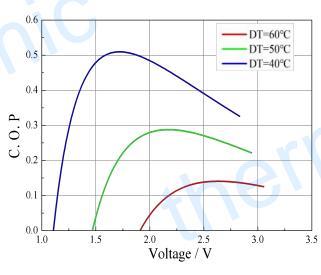
Performance Curves at Th=27 °C

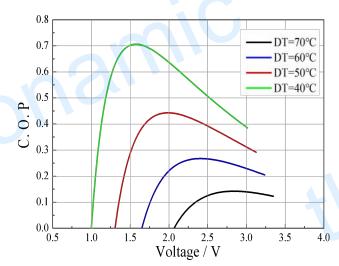
Performance Curves at Th=50 °C





Standard Performance Graph COP = f(V) of ΔT ranged from 0 to 30 °C





Standard Performance Graph COP = f(V) of ΔT ranged from 40 to 60/70 °C

Remark: The coefficient of performance (COP) is the cooling power Qc/Input power (V × I).

Operation Cautions

- Attach the cold side of module to the object to be cooled
- Attach the hot side of module to a heat radiator for heat dissipating
- Operation or storage module below 100 °C
- Operation below I_{max} or V_{max}
- Work under DC